

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s):	Janssen et al.	Examiner:	Unassigned
Application No.:	Unassigned	Group Art Unit:	Unassigned
Filed:	Herewith	Confirmation No.:	Unassigned
For:	METHOD FOR MANUFACTURING ENCAPSULATED ELECTRONIC COMPONENTS, PARTICULARLY INTEGRATED CIRCUITS	Docket:	903-51 CON
		Dated:	July 2, 2003

EXPRESS MAIL CERTIFICATE

Date: July 2, 2003 Label No.: EV261769716US

I hereby certify that on the date indicated above I deposited this paper or fee with the U.S. Postal Service and that it was addressed for delivery to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 by "EXPRESS MAIL Post Office to Addressee" service.

Barbara Kemmle
Name

Signature

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

INFORMATION DISCLOSURE STATEMENT

Sir:

In fulfillment of the requirements of candor and good faith set forth in 37 C.F.R. §1.56, Applicants submit herewith the following Information Disclosure Statement in accordance with the provisions of 37 C.F.R. §1.97 and §1.98.

As this Information Disclosure Statement is being filed before the issuance of the first Office Action, no fee is deemed necessary.

I. U.S. PATENTS

<u>Patent No./Inventor</u>	<u>Title</u>	<u>Issue Date</u>
3,635,754 to Beede	Adhesive Product	January 18, 1972
3,754,070 to Dunn et al.	Flash Free Molding	August 21, 1973
4,980,016 to Tada et al.	Process for Producing Electric Circuit Board	December 25, 1990
5,218,759 to Juskey et al.	Method of Making a Transfer Molded Semiconductor Device	June 15, 1993
5,693,573 to Choi	Semiconductor Package Lead Deflash Method	December 2, 1997
6,033,933 to Hur	Method for Attaching a Removable Tape to Encapsulate a Semiconductor Package	March 7, 2000
6,048,483 to Miyajima	Resin Sealing Method for Chip-Size Packages	April 11, 2000
6,087,202 to Exposito et al.	Process for Manufacturing Semi- conductor Package, Comprising an Integrated Circuit	July 11, 2000

II. FOREIGN PATENT APPLICATIONS

<u>Country</u>	<u>Document No.</u>	<u>Publication Date</u>
Japan	10209190 (Abstract)	August 7, 1998
Europe	EP 0 611 129 A2	August 17, 1994
Europe	EP 0 890 425 A1	January 13, 1999

All of the references listed above are also listed on Applicants' Form PTO-1449 which is attached to this Information Disclosure Statement for the convenience of the Examiner.

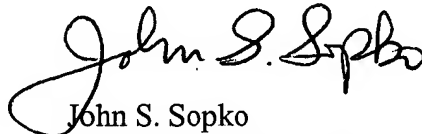
Each of these references have been cited in the priority application, U.S. Application No. 10/021,455, filed October 29, 2001, and copies of these references can be found in the priority file. Accordingly, copies of these references are not required to be submitted in the present application under 37 C.F.R. §1.98(d).

Applicant respectfully requests that each of these documents be made of record herein, listed on the "Notice of References Cited" to be issued in this application and printed on any patent which may issue from this application. Applicant also respectfully requests that a copy of the attached form PTO-1449, initialed by the Examiner, be returned to Applicant's attorney together with the next communication indicating that these documents have in fact been considered.

Applicant requests a prompt and favorable examination of the instant application.

Should the Examiner have any questions or comments concerning the above, the Examiner is respectfully invited to contact the undersigned attorney at the telephone number set forth below.

Respectfully submitted,

A handwritten signature in black ink, appearing to read "John S. Sopko". The signature is fluid and cursive, with the first name "John" being the most prominent.

John S. Sopko
Registration No. 41,321
Attorney for Applicants

HOFFMANN & BARON, LLP
6900 Jericho Turnpike
Syosset, New York 11791
(973) 331-1700

FORM PTO-1449 U.S. DEPARTMENT OF COMMERCE (Rev. 2-32) PATENT AND TRADEMARK OFFICE INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Use several sheets if necessary)	ATTY. DOCKET NO. 903-51 CON	SERIAL NO. Unassigned
	APPLICANT Janssen et al.	CONFIRMATION NO. Unassigned
	FILING DATE Herewith	GROUP Unassigned

U.S. PATENT DOCUMENTS

EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
		3,635,754	01/18/72	Beede			
		3,754,070	08/21/73	Dunn et al.			
		4,980,016	12/25/90	Tada et al.			
		5,218,759	06/15/93	Juskey et al.			
		5,693,573	12/02/97	Choi			
		6,033,933	03/07/00	Hur			
		6,048,483	04/11/00	Miyajima			
		6,087,202	07/11/00	Exposito et al.			

FOREIGN PATENT DOCUMENTS

EXAMINER INITIAL		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUB CLASS	TRANSLATION	
							YES	NO
		10209190	08/07/98	Japan				
		EP0611129A2	08/17/94	Europe				
		EP0890425A1	01/13/99	Europe				

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

EXAMINER

DATE CONSIDERED

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication with applicant.